L Number	Hits	Search Text	DB	Time stamp
79	1008	"lead frame" with (die or chip) with tape	USPAT; US-PGPUB	2004/09/05 08:49
80	1254	438/118.ccls.	USPAT; US-PGPUB	2004/09/05 09:01
81	1651844	@ad>19970211 or @rlad>19970211	USPAT; US-PGPUB	2004/09/05 08:49
82	60	("lead frame" with (die or chip) with tape) and 438/118.ccls.	USPAT; US-PGPUB	2004/09/05 08:49
83	16	(("lead frame" with (die or chip) with tape) and 438/118.ccls.) not (@ad>19970211 or @rlad>19970211)	USPAT; US-PGPUB	2004/09/05 08:49
84	745	438/126.ccls.	USPAT; US-PGPUB	2004/09/05 09:04
85	27	("lead frame" with (die or chip) with tape) and 438/126.ccls.	USPAT; US-PGPUB	2004/09/05 09:01
86	3	(("lead frame" with (die or chip) with tape) and 438/126.ccls.) not (@ad>19970211 or @rlad>19970211)	USPAT; US-PGPUB	2004/09/05 09:01
87	1064	438/127.ccls.	USPAT; US-PGPUB	2004/09/05 09:04
88	43	("lead frame" with (die or chip) with tape) and 438/127.ccls.	USPAT; US-PGPUB	2004/09/05 09:02
89	5	(("lead frame" with (die or chip) with tape) and 438/127.ccls.) not (@ad>19970211 or @rlad>19970211)	USPAT; US-PGPUB	2004/09/05 09:03
91	744	257/E23.125.ccls.	USPAT; US-PGPUB	2004/09/05 09:04
92	26	("lead frame" with (die or chip) with tape) and 257/E23.125.ccls.	USPAT; US-PGPUB	2004/09/05 09:04
93	13	(("lead frame" with (die or chip) with tape) and 257/E23.125.ccls.) not (@ad>19970211 or @rlad>19970211)	USPAT; US-PGPUB	2004/09/05 09:07
94	375	264/272.15.ccls.	USPAT; US-PGPUB	2004/09/05 09:08
95	4	("lead frame" with (die or chip) with tape) and 264/272.15.ccls.	USPAT; US-PGPUB	2004/09/05 09:07
96	2	(("lead frame" with (die or chip) with tape) and 264/272.15.ccls.) not (@ad>19970211 or @rlad>19970211)	USPAT; US-PGPUB	2004/09/05 09:07
97	770	264/272.17.ccls.	USPAT; US-PGPUB	2004/09/05 09:08
98	19	("lead frame" with (die or chip) with tape) and 264/272.17.ccls.	USPAT; US-PGPUB	2004/09/05 09:09
99	6	(("lead frame" with (die or chip) with tape) and 264/272.17.ccls.) not (@ad>19970211 or @rlad>19970211)	USPAT; US-PGPUB	2004/09/05 09:10
100	275669	casing or encapsulating or encapsulation	USPAT; US-PGPUB	2004/09/05 09:11
101	495	("lead frame" with (die or chip) with tape) and (casing or encapsulating or encapsulation)	USPAT; US-PGPUB	2004/09/05 09:11
102	27059	remov$3 with tape	USPAT; US-PGPUB	2004/09/05 09:27
103	62	(("lead frame" with (die or chip) with tape) and (casing or encapsulating or encapsulation)) and (remov$3 with tape)	USPAT; US-PGPUB	2004/09/05 09:11
104	22	((("lead frame" with (die or chip) with tape) and (casing or encapsulating or encapsulation)) and (remov$3 with tape)) not (@ad>19970211 or @rlad>19970211)	USPAT; US-PGPUB	2004/09/05 09:11
105	1	("6117710").PN.	USPAT; US-PGPUB	2004/09/05 09:12
106	10	("5157480" | "5177669" | "5200362" | "5200809" | "5273938" | "5276351" | "5296738" | "5450283" | "5483098" | "5604376").PN.	USPAT	2004/09/05 09:14
107	72	5894108.URPN.	USPAT	2004/09/05 09:16
108	1698	detach$3 with tape	USPAT; US-PGPUB	2004/09/05 09:27
109	252	(casing or encapsulating or encapsulation) and (detach$3 with tape)	USPAT; US-PGPUB	2004/09/05 09:27
110	1008	("lead frame" with (die or chip) with tape) and109	USPAT; US-PGPUB	2004/09/05 09:27
111	314	(("lead frame" with (die or chip) with tape) and109) not (@ad>19970211 or @rlad>19970211)	USPAT; US-PGPUB	2004/09/05 09:28
112	82236	438/$.ccls.	USPAT; US-PGPUB	2004/09/05 09:28

113	68	((("lead frame" with (die or chip) with tape) and109) not (@ad>19970211 or @rlad>19970211)) and 438/$.ccls.	USPAT; US-PGPUB	2004/09/05 09:28
114	4	((casing or encapsulating or encapsulation) and (detach$3 with tape)) and ("lead frame" with (die or chip) with tape)	USPAT; US-PGPUB	2004/09/05 09:29
115	709	438/for.371.ccls.	EPO; JPO; DERWENT; IBM_TDB	2004/09/05 09:33
116	486	438/for.379.ccls.	EPO; JPO; DERWENT; IBM_TDB	2004/09/05 09:33
117	1173	"lead frame" and (die or chip) and tape	EPO; JPO; DERWENT; IBM_TDB	2004/09/05 09:34
118	6	438/for.371.ccls. and ("lead frame" and (die or chip) and tape)	EPO; JPO; DERWENT; IBM_TDB	2004/09/05 09:35
119	3	438/for.379.ccls. and ("lead frame" and (die or chip) and tape)	EPO; JPO; DERWENT; IBM_TDB	2004/09/05 09:35